

1 TO WHOM IT MAY CONCERN:

2

3 BE IT KNOWN THAT I, JOHN M. POPOVICH, a  
4 citizen of the United States of America, residing in  
5 Solana Beach, in the County of San Diego, State of  
6 California, have invented a new and useful improvement  
7 in

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9 ELECTRONIC ASSEMBLY/SYSTEM WITH REDUCED COST, MASS, AND  
10 VOLUME AND INCREASED EFFICIENCY AND POWER DENSITY

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1                                    **BACKGROUND OF THE INVENTION**

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3                    This application is a continuation-in-part of  
4 prior pending U.S. application serial number 10/625,185  
5 filed July 23, 2003.

6                    The methods described and claimed herein  
7 relate generally to provision of electronic-optical  
8 packages, and more particularly to provision of grids  
9 or arrays of such packages supported in such manner as  
10 to facilitate their installation and use as in closely  
11 assembled or packed configurations.

12                   Large-scale LED displays are typified by the  
13 use of T 1 ¼ (5mm) packaged LEDs soldered to rigid  
14 printed circuit boards. Such circuit board/modules  
15 typically contain a large number of LEDs and must be  
16 replaced to correct for the failure of even a single  
17 LED. In addition to cost, weight and volume issues or  
18 problems, these displays are limited in resolution as a  
19 result of the LED package size (typically 0.2 inches in  
20 diameter), or about 300 times the plan form area of a  
21 bare LED (8000 times the volume), and they are limited  
22 in brightness by the small number of LEDs that can be  
23 placed in a given area, and also by the thermal  
24

1 resistance of the package and module design. The  
2 resolution limit is a function of spacing that is  
3 further restricted by package (LED) size. The  
4 brightness limit is a function of the number of LEDs  
5 per unit area and their individual light output, which  
6 is further dependent on the thermal resistance between  
7 the LED junction and the local environment. Also,  
8 existing LED signage and displays have limited ability  
9 to tailor the radiation emission pattern to the needs  
10 of the target/audience and thereby increase efficiency.  
11 Increased efficiency allows for reduced system and  
12 operating cost and/or more radiation delivered to the  
13 target.

14           There is need for improvements in the  
15 provision and operation of LED display assemblies that  
16 overcome problems of heating and inability to  
17 adequately transfer or dispose of heat generated by LED  
18 operation; problems of inadequate LED support on  
19 substrates or circuit boards; problems resulting from  
20 lack of flexibility of the LED support means;  
21 difficulties in manufacturing close packed LED  
22 displays; and other problems and difficulties as will  
23 appear.

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1 a grid characterized by ease of conformance to selected  
2 shape, curvature, or complex configuration after the  
3 LED array is attached to the grid, the grid having  
4 flexibility to enable such compliance to desired  
5 shaping.

6 Another object is to effect and/or guide flow  
7 of coolant fluid through or along a shape compliant  
8 screen incorporating such LEDs. In this regard, the  
9 screen is amenable to fitting to

- 10 i) a substrate on which LED bases are  
11 placed, and/or
- 12 ii) a superstrate provided in  
13 association with the screen and  
14 LEDs, to provide structural  
15 strength to the assembly.

16 Yet another aspect of the improved is to  
17 provide a first protective sheet facing the diodes to  
18 pass light emitted by the diode array; and to provide a  
19 second sheet at the opposite side of the screen and  
20 diodes, the first and second sheets forming an  
21 enclosure within which coolant fluid is flowable. The  
22 screen itself may be dark or darkened to increase  
23 viewing contrast with the LED array, during its  
24 operation.

25 A further feature is provision of the  
26 electrical conductors to include primary conductors

1 extending generally in one direction, and secondary  
2 conductors extending generally in another direction,  
3 the LEDs mounted on the primary conductors, and having  
4 terminals extending to the secondary conductors for  
5 electrical association thereto. In this regard,  
6 secondary conductors are typically provided to have one  
7 of the following:

- 8                   i) substantial spacing therebetween to  
9                   pass coolant fluid through the  
10                  screen,
- 11                  ii) reduced spacing therebetween, to  
12                  pass coolant fluid primarily  
13                  parallel to the screen,
- 14                  iii) cross sections which are  
15                  substantially less than the cross  
16                  sections of primary conductors  
17                  which support diodes,
- 18                  iv) junctions with diode wires.

19                  Yet another feature is provision of a screen  
20 display incorporating diodes or diode devices, wherein  
21 each diode is provided to include a light emitter or  
22 emitters, a transparent container having a window area,  
23 the emitter supported within the container, and a  
24 reflector within the container to reflect emitted light  
25 toward said window. As will appear, an electrical lead  
26 or leads may be provided to extend with helical

1 configuration within the container, such as a glass  
2 tube, to the emitter or emitters. The lead or leads  
3 may be formed to have flattened, or generally  
4 rectangular cross sections for stable support of the  
5 emitter or emitters.

6           The improved may include provision of a  
7 metallic base carrying the container, and through which  
8 said lead or leads extend. The base typically is  
9 formed to have an edge portion defining a recess for  
10 reception of a support for the diode, allowing diode  
11 rotation about the support. Multiple of the diodes may  
12 be supported by a conductor or conductors in a screen,  
13 and to have their windows oriented to face in the same  
14 or selected directions. The diodes may be rotated, or  
15 be rotatable, about axes defined by their supporting  
16 conductors.

17           Additional features include provision of  
18 certain power providing conductors that comprise first,  
19 second, and third pairs of wires to transmit electrical  
20 energization to red, green and blue LED pixels,  
21 respectively; provision of LED primary, secondary and  
22 tertiary wires electrically connected to the red, green  
23 and blue pixels, respectively, said primary wires clamp  
24 connected to said first pair of wires, said secondary  
25 wires clamp connected to said second pair of wires, and  
26 said tertiary wires clamp connected to said third pair

1 of wires; provision for clamped nesting of such  
2 primary, secondary and tertiary wires; provision of  
3 certain conductors that extend at an acute angle or  
4 angles relative to others of said conductors; provision  
5 of protector means such as a plate or plate, or a  
6 screen or screens at the front or rear of the grid, and  
7 with air passing openings, as will appear.

8 The method as disclosed also includes:

- 9 a) providing multiple LEDs in a display  
10 array, and  
11 b) selectively electrically energizing the  
12 LEDs in the array to adjust the display,  
13 c) cooling the display array.

14 A further aspect of the includes selectively  
15 adjusting the positioning of the LEDs in the array to  
16 controllably vary the overall display.

17 These and other objects and advantages of the  
18 invention, as well as the details of an illustrative  
19 embodiment, will be more fully understood from the  
20 following specification and drawings, in which:

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## 22 DRAWING DESCRIPTION

23

24 Fig. 1 is a perspective view showing  
25 provision of one form of grid or screen incorporating



1 LEDs, and Fig. 1a is similar but shows coolant flow  
2 through the screen;

3 Fig. 2 is a perspective view showing  
4 provision of another form of grid or screen  
5 incorporating LEDs, and showing coolant flow primarily  
6 adjacent and across the screen and diodes;

7 Fig. 3 is a view like Fig. 2 but showing  
8 coolant flow primarily through the screen and past  
9 diodes;

10 Fig. 4 is a top plan view of an array of  
11 diodes on a screen similar to that of Fig. 1, and  
12 showing open spaces between conductors to pass coolant  
13 fluids;

14 Fig. 5 is a top plan view of an array of  
15 diodes on a screen, similar to that of Fig. 2, the  
16 conductors provided in closely packed relation;

17 Fig. 6 is a view like that of Fig. 5, but  
18 showing a different configuring of electrical  
19 conductors;

20 Figs. 7 and 8 are perspective views of two  
21 different forms of LEDs as provided;

22 Figs. 9-12 are perspective views of sections  
23 of electrical conductors as provided;

24 Fig. 13 shows weaving of electrical  
25 conductors;

1           Fig. 14 is an edge view taken on lines 14-14  
2 of Fig. 13;

3           Fig. 15 is a perspective view of a ball grid  
4 connection to a screen;

5           Fig. 16 is a plan view of a ball grid  
6 connection to a screen;

7           Fig. 17 is an elevation showing a ball grid  
8 connection to a screen;

9           Fig. 18 is a perspective view showing yet  
10 another screen configuration;

11          Fig. 19 is an edge view of the screen of Fig.  
12 18; and

13          Figs. 20-23 show arrangements of electrical  
14 conductors forming screens, and arrays of LEDs mounted  
15 thereon;

16          Fig. 24 is a view showing screen cooling;

17          Fig. 25 is a section taken through an LED  
18 package as provided;

19          Fig. 26 is a section taken on lines 26-26 of  
20 Fig. 25;

21          Fig. 27 is a view showing a display provided  
22 to embody multiple LED packages of the type shown in  
23 Figs. 25 and 26;

24          Fig. 28 is a view showing a display provided  
25 to embody multiple LED packages as shown in Figs. 25  
26 and 26, the packages mounted on a conductor screen of

1 the type shown in Fig. 1; and Fig. 28a is a  
2 modification;

3 Fig. 29 shows an LED package mounted on a  
4 screen conductor and transmitting light to a reflector;

5 Fig. 30 is a schematic diagram of a sign that  
6 incorporates the LED supporting grid, and with address  
7 wires provided to extend at acute angles;

8 Fig. 31 is a perspective view of a wire  
9 bundle as provided;

10 Fig. 32 is a cross section taken through the  
11 Fig. 31 wire bundle;

12 Fig. 33 is a section taken on lines 33-33 of  
13 Fig. 32;

14 Fig. 34 is a view of protective metallic  
15 plate, with air passing openings;

16 Fig. 35 is a section taken through a grid as  
17 described, with protective mesh at front and rear sides  
18 thereof;

19 Fig. 36 is a view like Fig. 35, showing use  
20 of air passing louvers;

21 Fig. 37 is a plan view showing multiple light  
22 emitter packages supported by wires, in an array;

23 Fig. 38 is an enlarged view of a portion of  
24 the Fig. 37 array;

25 Fig. 39 is a view of two light emitter  
26 packages in Fig. 38, but in rotated positions;

1           Fig. 40 is an end view of a connector as  
2 shown in Figs. 38 and 39;

3           Fig. 41 is an end view of a conductor conduit  
4 supporting conductor wire terminal holders;

5           Fig. 42 is a top plan view taken on lines 42-  
6 42 of Fig. 41;

7           Fig. 43 is a perspective view of a conductor  
8 wire channel, as also seen in Fig. 41;

9           Fig. 44 is a view showing retraction of  
10 conductor wires;

11           Fig. 45 is an enlarged and rotated view of  
12 Fig. 42;

13           Fig. 46 is a front elevation showing  
14 locations of pixel packages on a fragmentary grid of  
15 addressing wires arrayed at 45° relative to conductor  
16 wires;

17           Fig. 47 is an enlarged view, like Fig. 44,  
18 but taken at the opposite end of the grid;

19           Fig. 48 is a schematic perspective view  
20 showing pixel package adjustment rotation about the  
21 package axes;

22           Fig. 49 is a schematic perspective view  
23 showing pixel package with adjustment rotation capacity  
24 about the axis of the package supporting conductor;

25           Fig. 50 shows in schematic form a  
26 representative grid having supporting wires or

1 conductors, and pixel packages adjusted at different  
2 angles, as for use in a billboard;

3 Fig. 51 is a schematic view showing pixel  
4 packages on a grid, and with control electronic  
5 circuitry integrated into the packages;

6 Fig. 52 is a schematic view like Fig. 51,  
7 with control circuitry in zones or modules at edges of  
8 the grid;

9 Fig. 53 is a fragmentary view showing wire  
10 conduit wire conduit tensioning;

11 Fig. 54 is a schematic view showing use of  
12 bowed end wall mirrors in a pixel package;

13 Fig. 55 is a view like Fig. 54, but rotated  
14 90° about the package axis.

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#### 16 DETAILED DESCRIPTION

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18 Fig. 1 shows a screen 10 forming a grid of  
19 electrical conductors. As illustrated, the conductors  
20 include like primary conductors 11 extending generally  
21 in one direction, and designated as an X-direction; and  
22 secondary conductors 12 extending generally in another  
23 direction, designated as a Y-direction. As shown, the  
24 primary conductors preferably have overall diameters  $d_1$   
25 or cross sections greater than the overall diameters  $d_2$

1 or cross sections of the secondary conductors, and the  
2 latter extend over and under the conductor 11 in a  
3 weaving or mesh relationship as at 12a and 12a'. There  
4 is space as at 15 between successive parallel  
5 conductors 11; and there is space as at 16 between  
6 successive undulating conductors 12, whereby coolant  
7 can flow downwardly through the screen via spaces 15  
8 and 16 and near or adjacent diodes, to remove heat  
9 generated by diode operation.

10           Light emitting diodes are located or mounted  
11 in an array on various conductors, as shown on crests  
12 of conductor 12, and in such manner that each diode is  
13 in electrical communication with two conductors,  
14 establishing a circuit path from a conductor 11 to a  
15 conductor 12, via the diode internal circuit. See  
16 conductor energization controls 20 and 21 for two  
17 representation diodes 22 and 23, with circuit paths  
18 (for diode 22) at 24, 11a, 22, 25, junction 26, 12a,  
19 12b and 27; and circuit paths (for diode 23) at 28,  
20 11b, 23, 29, junction 30, 12a, 12b, and 29. Controls  
21 20 and 29 are interconnected so that diodes 22 and 23  
22 can be selectively energized in timed relation. Diode  
23 22 is mounted on the top side or crest of conductor  
24 11a, and diode 23 is mounted on the top side of  
25 conductor 11b. Other diodes as shown are similarly  
26 mounted and selectively controlled by controls

1 indicated in bank 31, controls 20 and 21 considered as  
2 part of that bank. Electrical connections to metallic  
3 wires in the conductors are made by removal of or  
4 penetration through conductor insulation. Wires 25 and  
5 29 extend in the Y-direction, and may be insulated.  
6 Junctions as at 26 and 30 are provided on all crests of  
7 secondary conductors 12, and all LEDs are mounted on  
8 conductors 11, and protectively between sequential  
9 crests of conductors 12.

10           The electrical conductors may comprise  
11 insulated metal wires that act as electrical and  
12 thermal conductors and that also serve as structural  
13 load conductors, for arrays of such diodes. See for  
14 example Fig. 9 showing metallic conductor 40 having a  
15 square cross section, and a layer 41 of dielectric  
16 insulation thereon; Fig. 10 showing metallic conductor  
17 42 having tubular cross section with bore 42a, and a  
18 cylindrical layer 43 of insulation thereon; Fig. 11  
19 showing circular cross section metallic wire at 44,  
20 tubular insulation layer 45, tubular cross section  
21 metallic wire 46, and tubular layer of insulation 47;  
22 and Fig. 12 showing solid metallic wire 48 and  
23 insulation 49 thereon, 48 being circular and 49 being  
24 tubular. Fig. 7 shows a six-sided LED body 80 with  
25 electrical terminal areas 81 and 82; and Fig. 8 shows a  
26 similar LED body with terminal areas 83 and 84.

1           Fig. 1a is like Fig. 1, showing an array of  
2 LEDs 23 and 24 staggered in the Y-direction at one side  
3 of the screen defined by the interwoven conductors 11  
4 and 12. Coolant such as air flows at 54, downwardly  
5 toward and over the diodes and through the screen  
6 defined by spaced conductors 11 and 12. Air may also  
7 be caused to flow generally parallel to the screen, as  
8 in the X or Y direction, to cool the screen and diodes.  
9 Heat generated by the diodes is carried away by coolant  
10 flow. Note diode wire junctions 60 with and at the  
11 tops of the supporting conductors 12, maximally exposed  
12 to coolant flow for heat transfer to coolant. The  
13 conductors 11 are large enough in diameter to support  
14 the mounted and exposed diodes 22 and 23 and other  
15 similar diodes, arrayed as shown.

16           In Figs. 2 and 5, the conductors 11 are  
17 generally the same as the conductors 11 in Fig. 1, and  
18 are spaced apart as seen at 60. The conductors 12 are  
19 arranged in side by side pairs, as seen for example at  
20 12' and 12', and 12'' and 12''. Successive pairs of  
21 such conductors pass over and under conductors 11, as  
22 shown. Like pairs 12' pass together over a conductor  
23 11, along its length, and like successive pairs 12''  
24 pass together over the next conductor 11, along its  
25 length in staggered relation in the X-direction in  
26 relation to closest pairs 12'; and portions of the



1 pairs 12'' nest between portions of the pairs 12', at  
2 locations 62 between conductors 11, as is clear from  
3 Fig. 5. A close packed assembly is thereby achieved.  
4 As before, LEDs 23 are mounted on exposed tops of  
5 sequentially alternate conductors 11b; and LEDs 22 are  
6 likewise mounted on exposed tops of sequentially  
7 alternate conductors 11a. Each LED has a wire 63  
8 connecting it to the top of a conductor 12 in a pair of  
9 such conductors, as at a junction as seen at 64.  
10 Insulation is removed or penetrated to enable  
11 electrical communication between LED wire 63 and the  
12 metal wire within a conductor.

13 In Fig. 2, coolant is shown flowing at 66  
14 parallel to the plane of the conductor formed screen;  
15 and in Fig. 3, coolant is shown flowing at 67 generally  
16 normal to the plane of the conductor formed screen, and  
17 through the screen, for removing heat from the LEDs and  
18 screen, such heat produced by LED operation. Fig. 3 is  
19 generally like Fig. 5, except that the pairs of  
20 conductors 12' and 12' are spaced from the pairs 12''  
21 and 12'' to form air passing openings.

22 Fig. 4, which is an assembly similar to that  
23 shown in Fig. 1, illustrates provision of spaces 66  
24 formed between successive straight conductors 11 in the  
25 Y-direction, and between undulant over and under  
26 extending conductors 12 in the X-direction. Those

1 spaces facilitate flow of coolant fluid through the  
2 screen or grid of conductors. The X and Y directions  
3 are substantially normal to one another.

4           It will be understood that the screen as  
5 shown facilitates its bending or warping, particularly  
6 about an axis or axes parallel to the X-direction  
7 extents of conductors 11 to conform the screen to  
8 desired shape or shapes. This may alter the perceived  
9 LED illumination emanating from different portions of  
10 the screen, as may be desired.

11           In Fig. 6, the conductors 11 are arranged to  
12 extend in spaced parallel relation in the X-direction,  
13 as in Fig. 1. Successive conductors 12 are closely  
14 packed, so that portions 12a' of conductors 12a closely  
15 nest between portions 12b' of conductors 12b,  
16 conductors 12a alternating between conductors 12b. LEDs  
17 23 are located on the exposed tops of conductors 11b,  
18 whereas LEDs 22 are located on the tops of conductors  
19 11a which alternate between conductors 11b. Wires from  
20 LEDs 22 extend to junctions 26 at the tops of  
21 conductors 12b overlying conductors 11b, whereas wires  
22 from the LEDs 23 extend to junctions 30 at the tops of  
23 conductors overlying conductors 11a.

24           Figs. 13 and 14 show a mesh 90 of interwoven  
25 conductors 11 and 12, with LEDs 91 at the crests of  
26 conductors 11, which have wave-like configuration , as

1 do conductors 12. This facilitates bending or warping  
2 of the screen or mesh about axes extending in both the  
3 X and Y direction, to accommodate to desired curved  
4 shaping as on object 92. LED wires 91a extend to  
5 junctions 94 on conductors 12.

6 Figs. 15 and 16 show a screen or mesh 100,  
7 similar to mesh 90 in Figs. 13 and 14, with X direction  
8 conductors 101 interwoven with Y direction conductors  
9 102. A substrate 103 extends beneath the mesh, and  
10 dielectric spacers such as spheres or balls 104 are  
11 located between 100 and 103 to engage and position them  
12 relative to one another. In Fig. 16, LEDs 106 mounted  
13 on crests of conductors 101, have wires 106a extending  
14 to junctions 107 on crests of conductors 102.

15 Fig. 17 shows positioning balls 110 between  
16 the tops of conductors 12 woven above and below  
17 conductors 11. Balls 110 also serve as protection and  
18 spacing means. LEDs are mounted on conductors 11  
19 between conductors 12. A superstrate 111 may be  
20 located at the tops of the balls 110. Superstrate 111  
21 may be a transparent plate, to pass light emitted by  
22 the LEDs.

23 Figs. 18 and 19 show a mesh 120 similar to  
24 that seen at 90 in Figs. 13 and 14. The "open-weave"  
25 conductors are seen at 111 and 112; and LEDs 113 are  
26 mounted on crests of certain conductors such as 111.

1 LED wires 130 extend to junctions 131 on conductors  
2 112. The latter may have concentric configuration.

3 Figs. 20-23 show alternative screen and LED  
4 configurations.

5 Fig. 24 shows a screen 120 like any of the  
6 described screens, with cooling air 121 blown at 122  
7 into a space 123 below the screen, to flow adjacent the  
8 screen and upwardly through the screen. A housing is  
9 seen at 124. Actuators 125 and 126 may be provided to  
10 actively and repeatedly displace, deform or warp the  
11 screen, as for an active sign display.

12 Referring now to Figs. 25 and 26, the  
13 illustrated LED or LED 'pixel' package, or diode  
14 package 150 includes a light emitter or emitters 151  
15 within a transparent container, one example being a  
16 glass tube 152 having a hemispherical end 152a. A  
17 window area 152b is defined by tube 152, or container,  
18 for transmission of emitted light in a direction or  
19 directions 153. A reflector 154 is located within the  
20 tube, and has a reflecting surface 154a for reflecting  
21 emitted light in a forward direction 153, through the  
22 window and to the exterior. The reflector may have  
23 edges 154b engaging or supported by the tube interior  
24 wall 152c.

25 An electrical lead or leads indicated at 156  
26 extends with helical configuration into the tube and

1 within the tube, to the emitter or emitters, that  
2 configuration providing support. The lead or leads  
3 preferably has or have a flattened or generally  
4 rectangular configuration seen in Fig. 26. Wires  
5 contained in the lead or leads may include 'red',  
6 'green' and 'blue' (relating to emitted light  
7 color) and an additional wire, such as an electrical  
8 neutral or return wire, to the emitter or emitters.  
9 The wires may consist of AWC32 copper multifilar and or  
10 AWC26 copper wire or AWG26 4 conductor insulated copper  
11 multifilar wire helically wound around a rectangular  
12 cross-section AWG18 insulated copper wire. A metallic,  
13 as for example aluminum base 157, has an edge recess  
14 158 receiving the end of the tube 152, and supporting  
15 the tube. Specularly reflecting aluminum walls 159 and  
16 160 are provided in the tube, and support the reflector  
17 154, as at endwise locations 161 and 162.

18           The base 157 defines a through opening 163  
19 passing the lead or leads; the base also defines an end  
20 recess 164 filled with potting compound 165 as for  
21 example epoxy resin. The lead or leads pass through  
22 that compound. The base also has an edge portion  
23 defining an annular recess 168, for reception of a  
24 package support or support portion 169, as for example  
25 a portion of the conductor 11a as seen in Fig. 1. The  
26 recess 168 preferably has cylindrical wall

1 configuration, allowing rotation of the diode about an  
2 axis 170 defined by the recess or conductor. Diode or  
3 pixel replacement is also facilitated. Lead wires may  
4 be connected to conductors 11 and 12 of the screen, as  
5 referred to above.

6           Fig. 27 shows the LED packages 150 of Figs.  
7 25 and 26 arranged in a display sequence or  
8 configuration. Fig. 28 shows the Fig. 25 and 26 LED  
9 packages mounted to mesh defining conductors 11 and 12,  
10 so that the LED packages are carried by the mesh  
11 conductors 11 and are rotatable about axes 170, as  
12 referred to. Integrated pixel electronics is thereby  
13 provided. Note leads 156 connected at 156a to  
14 conductors 12. Fig. 29 shows LED package 150 mounted  
15 on a conductor 11, and transmitting light to a  
16 reflector 180.

17           Fig. 30 shows a sign or array employing LED  
18 packages as disclosed. The display incorporates  
19 vertical conductors 300, with representative addressing  
20 wires 301 and 302 extending at acute angles, for  
21 example 45° across and relative to wires 300. Wires  
22 301 are extensive of wires 302 in a geometric sense.  
23 Other addressing wires are indicated in broken lines,  
24 as at 302a. LED packages are shown at 303 carried by  
25 wires 300. This configuration, shown schematically,  
26 achieves reduced lengths of addressing wires, as

1 compared with horizontal wires. Connections 304 and  
2 305 to wires 300, 301, and 302a are made at the screen,  
3 i.e. array perimeter.

4 Figs. 31-33 are sections showing details of  
5 construction of the LED addressing wires which may be  
6 of multifilar construction. Referring to Fig. 31, wire  
7 301, numerals 306 and 307 refer to LED red light  
8 emitting pair; 308 and 309 refer to green emitting  
9 pair; and 310 and 311 refer to blue light emitting  
10 pair. A pair of red AWG 18 insulated copper wires is  
11 used to activate the red LEDs for a row of pixels.  
12 This wire pair and its neighboring wire pairs may be  
13 helically wound around an insulated central core that  
14 may serve as a tensile element. AWG 26 insulated  
15 copper wires from the pixel may be nested between wire  
16 pairs of like color. An insulated metal retainer may  
17 be used to compress the pixel wires against the power  
18 supply wires.

19 Numerals 313-315 designate three insulated  
20 copper wires from the three pixels, respectively,  
21 nested between the referenced wire pairs. A small  
22 amount of insulation is removed at wire regions to  
23 establish electrical connection between 313 and 306 and  
24 307; between 314 and 308 and 309; and between 315 and  
25 310 and 311.. A stainless steel retainer 316 extends  
26 about the wire assembly, and holds the wires in

1 compression at the central regions, for example as seen  
2 at 317, 318, and 319 in Figs. 32 and 33. The retainer  
3 may take the form of a split ring fastener that engages  
4 the wires 313-315 and may yieldably deform them at  
5 their contact points 317-319.

6           Fig. 34 schematically shows a metal plate 316  
7 that may be used and positioned as an absorber of  
8 sunlight that passes through a display sign array  
9 incorporating devices as described above. It also  
10 blocks light transmitted toward the rear of the sign  
11 array. As such, the plate 316 may be regarded as  
12 overlapping the array at the rear thereof. The angled  
13 slits 316a that extend through the plate pass cooler  
14 air (possibly blower induced) flowing in the space  
15 between the plate and the array. Plate 316 also  
16 provides mechanical protection at the back of the  
17 display. Fig. 34 also represents a side view of an  
18 array of overlapping elements that absorb sunlight and  
19 extraneous radiation while allowing the passage of  
20 cooling air. The array creates a thermal chimney  
21 effect to further increase cooling air flow and this  
22 effect may be further enhanced by the use of array  
23 surfaces with high absorptivity for sunlight and low  
24 emissivity in the longwave infrared region. In  
25 addition the array provides mechanical protection for  
26 signage and display elements.



1           Fig. 35 is a section showing protective  
2   metallic screens 317 at the back and front sides of the  
3   display array schematically indicated at 318. Such  
4   screens may pass cooling air, blower driven at 319.  
5   Fig. 36 is like Fig. 35, but shows louvers or slots 320  
6   in place of screens 317.

7           Screens may be used in place of circuit  
8   boards and conductors on or as film circuitry. Screens  
9   can provide power and signal conduits as at 300 or 302  
10   in Fig. 30, with reduced cost, mass, and volume, while  
11   providing paths between the conduits for flow of  
12   cooling fluids to allow systems/products with greatly  
13   reduced thermal resistance and/or increased power  
14   density operation. Screens may also allow optical  
15   communication between circuit elements via open regions  
16   between the wires. Screens greatly simplify the  
17   manufacture of 3D electronics, allow mechanical  
18   compliance, and may behave somewhat elastically to  
19   provide pressure type electrical contacts. Screens may  
20   have diodes electrically connected to the junctions  
21   between crossing wires and/or be in contact with  
22   electronic circuitry on chip or chips that provides  
23   diodes and/or electrically switchable elements to  
24   control the flow of electrons through the screen array.  
25   Connection schemes such as solder and including ball  
26   grid arrays are also a possible means of connection.

1 Screen and chip arrangements include ''Z Fold''  
2 serpentine/sinuous screen with chips between each layer  
3 and spiral/helical screens with chips between each  
4 layer/rotation. Screens are also good candidates for  
5 neural net architectures. Connection with input/output  
6 elements may be via ends/edges of screens and employ  
7 contact means such as solder, conductive adhesive,  
8 and/or mechanical/pressure contact. See 304 and 305 in  
9 Fig. 30.

10 Fig. 28a shows modifications in the manner of  
11 supporting LEDs and their electrical connections, in an  
12 array. The LEDs appear at 500 and are adjustably,  
13 and/or removably supported on conductors 501, which may  
14 be power conductors, as described in Fig. 25.  
15 Addressing wires or conductors, are shown at 502, and  
16 may take the multi-filer form as shown in Figs. 31-33.  
17 Wires 502 extend at acute angles (for example 45°)  
18 relative to conductors 501, extending in direction or  
19 directions 504. Coolant gas passing spaces between  
20 structure appear at 505. Local electronic circuitry,  
21 in the LED packages are seen at 506. Pixel package  
22 circuitry is indicated at 507 in the packages. Local  
23 addressing wire branches 502a extend (i.e. branch) from  
24 the wires 502 to 156, as described above. Wires 502 and  
25 conductors 501 form the grid or screen. Linking  
26 connectors 540 may be provided as sown to connect

1 successive conductors 501, so as to allow or restrict  
2 flexing of the screen or array.

3 Figs. 37-39 show rows and columns of light  
4 emitting packages (LEDs) 401 generally of the type  
5 referred to above, and supported by conductor wires 402  
6 running vertically, in the drawing. Addressing  
7 (control) wires appear at 403, and run at acute angles,  
8 as for example  $45^\circ$ , relative to wires 402. Wires 402  
9 and 403 form a grid, with coolant fluid passing  
10 passages 406 through the structure. The packages 401  
11 contain internal mirrors 407 and 408 convex toward one  
12 another to reflect LED emitted light. Clips 409 are  
13 connected to bulges 410 on wires 402, to retain the  
14 wires in spaced relation as shown, and to block wire  
15 402 rotation about their axes. Fig. 40 is an end view  
16 of a clip. The LED packages are electrically connected  
17 to wire 402 (that extend through grooves 412 in the  
18 bases of the LEDs), and to wires 403, via leads 413.  
19 See also circuitry 506 and 507, as described above.

20 Figs. 41-43 show a wire conduit 415, in the  
21 form of a metallic channel, for example. It supports  
22 or contains closely spaced conductor wires 402a in zone  
23 416, and closely spaced addressing wires 403a, in zone  
24 417, outside the display or grid, or at the edges of  
25 the grid. The items 402a and 403a shown in Fig. 41  
26 represent wire cross sections, or wire passing openings

1 in a plastic sheet, or plate, or support 417, carried  
2 by the conduit. Numeral 419 may represent a conduit  
3 support. See also Fig. 53 showing stabilizing tension  
4 springs 420 and 421 connected at 420a and 421a to  
5 support 419.

6 Fig. 42, a top plan view, also shows studs  
7 422 forming wire terminals carried by conduit 415.

8 Figs. 44 and 47 show conductor wires 402  
9 having bends 402b and receiving bosses or retainers  
10 425. See also address wires 403 that loop at 403a  
11 about retainers 425. A holder 426 extends crosswise of  
12 402 to hold them in position. Fig. 45, like Fig. 42,  
13 also shows wire bends 402b looping about retainers 425.  
14 Retainers 422 also anchor the addressing wires 403,  
15 having connections 403a.

16 Fig. 46 schematically shows parallel  
17 conductor wires 432 extending vertically, and  
18 addressing wires 433 extending at 45° angles relative  
19 to wires 432, thereby forming a grid. LEDs i.e. pixel  
20 packages 440 are carried by the grid, as described  
21 above, and electrically connected to the wires 432 and  
22 433. Electronic controls to control the LEDs are  
23 indicated at 437. A frame for the grid is shown at  
24 438.

25 Fig. 48 schematically shows a pixel package  
26 440 peripherally attached to a conductor wire 432, as

1 via an annular groove 440a in 440, allowing adjustable  
2 rotation of 440 (see arrows 442) about the package axis  
3 443. Fig. 49 shows adjustable rotation of the package  
4 440 about the lengthwise axis of conductor 432. See  
5 arrows 444. Fig. 50 schematically shows an array 446  
6 of LED packages 440, with the packages in different  
7 rows having different adjusted angularities, for  
8 variably directing emitted light in selected  
9 directions.

10 Fig. 51 schematically shows an array 450 of  
11 pixel packages 451, which have electronic control  
12 circuitry 452 within the pixel envelopes. In Fig. 52,  
13 the modified array 450a of LED pixel packages 451a has  
14 control circuitry 452a at edges of the array. Array  
15 wires 453 and 454 form grids.

16 Figs. 54 and 55 show LED pixel package  
17 elements the same as in Figs. 38 and 39. Emitted  
18 radiation is within included angle  $\alpha$ , in Fig. 55.  
19 Azimuth or radiation is reduced by vertical axis  
20 parabolic mirror trough, indicated at 460.

21 A preferred form of the invention appears in  
22 Figs. 25-33 and Figs. 37-39.

23 As disclosed herein large-screen modular  
24 displays and signs are enabled, along with various  
25 curvatures and complex geometric forms. Also, large

1 scale video displays, and projection displays as for  
2 billboards are made possible. Low volume, low mass, low  
3 cost, high brightness, high resolution and high  
4 efficiency are enabled. Double sided displays can be  
5 provided. LEDs can be placed on opposite sides of the  
6 screen, and the screen can serve as a pattern for LED  
7 placement.

8 LED bases can be placed on a transparent  
9 substrate, or the screen can be provided as a polymer  
10 film or sheet.

11 Screen and superstrate may collectively  
12 provide mechanical, structural strength. Superstrate  
13 may be thin or layered to allow second or third flexure  
14 modes. Superstrates may be thin to reduce sideways  
15 transmission of radiation from LEDs. Some LED sideways  
16 light transmission can be provided for integrating  
17 between pixels.

18 Provision is made for use of means to use  
19 conductive/red LEDs. Screen elements can be connected  
20 to side faces of LEDs via conductive adhesives, solder,  
21 amalgams, indium, stabilite<sup>22</sup>, and conductive grease.  
22 A metallic superstrate can be used.

23 Red LEDs can be provided with two conductors  
24 on same side (UEC red on sapphire)

25 Superstrates may have high refractive indices  
26 to increase usable radiation (polycarbonate 1.59)

1           Superstrates may have transparent adhesive  
2 layer, thermoplastic, thermoset, pressure sensitive  
3 features.

4           The screen can be deformed after weaving,  
5 during manufacture, or deform screen before and/or  
6 during weaving. Screen warp and woof wires of  
7 different metals can be used to reduce the possibility  
8 of electrical shorting.

9           Another modification comprises an array of  
10 light emitting diodes periodically placed on the weft  
11 wires of a woven aluminum and/or copper screen (wire  
12 cloth) with the weft wires acting as one conductor, and  
13 the warp wires acting as the opposite conductor. The  
14 wires may be electrically isolated at their crossing  
15 points by such means as anodic coatings and/or by the  
16 addition of inorganic or organic over-coatings. The  
17 LEDs can be activated by pulsed and/or continuous  
18 current and may be addressed as a whole or in groups or  
19 individually as in an active video display by control  
20 of conductor energization. Woven wire screen provides  
21 a very low cost substrate.

22           Additional benefits include efficient heat  
23 transport, low mass, low volume, reel to reel  
24 manufacturing with screen travel between reels and  
25 roll-up on a reel with LEDs placed in position. This  
26 allows freedom of display shape, transportable in a

1 roll, ability to be held in tension, in a wide range of  
2 materials and sizes.

3           A video display may include an X-Y grid of  
4 light emitting diodes placed on an aluminum woven  
5 screen suspended or placed between a transparent  
6 polycarbonate sheet and another enclosing sheet on the  
7 opposite side. An aluminum sheet with gaps between the  
8 screen and the enclosing sheet become sufficient to  
9 allow forced air to enter and flow upward between the  
10 polycarbonate sheet and the screen, through the screen  
11 and exiting at the top rearmost part of the screen.

12           Conductor wires act as structural conductors,  
13 electrical conductors, and thermal conductors, and may  
14 also be provided with a black region made especially  
15 effective because of 'cavity effect'. Wires may vary  
16 in size, materials, coatings etc. with axis, e.g.  
17 stainless steel wire may be used in tension in one axis  
18 direction and copper or aluminum wire of smaller  
19 diameter may be used in opposite axis direction (i.e.  
20 X-Y axes).

21           Manufacture may include placement of a screen  
22 on PTFE coated needle/cone array/drum to allow coating  
23 of die/wire bond/adhesive attach/screen without  
24 clogging holes; then forcing fluid through the screen  
25 to prevent clogging. Screens can be spaced apart by  
26 use of beads or spheres.



1           Electrostatic or electromagnetic powering of  
2 LEDs is possible, and particularly pulsed operation, as  
3 with LED video displays. High applied voltage allows  
4 smaller conductor cross sections.

5           LEDs with junction faces on metal, or with  
6 good junction heat transfer/thermal capacitance, can  
7 withstand very high voltage spikes.

8           Patterned superstrate and/or substrate may  
9 act as one conductor and screen or substrate as another  
10 conductor.

11           Anisotropic screens may be provided with  
12 wires along one axis of a different material than wires  
13 extending along another axis (thickness, form, alloy.  
14 Tensile strength and flexibility may be more important  
15 in one axis e.g. opposite roll axis or row axis;  
16 dissimilar metals are more apt to form dielectric  
17 regions at points of contact and this may be encouraged  
18 via processing and/or choice of material properties and  
19 coatings; a current flow in one LED row may be  
20 several times greater than current flow in another LED  
21 row.

22           Advantages and benefits of the Fig. 25 to 28  
23 described LED device construction include:

24           SPATIAL TUNING: Benefits accruing from the  
25 ability to aim the radiation from the emitters to the  
26 target include a reduction in emitter cost and/or

1 electrical system cost and/or operating cost and/or  
2 increased radiation delivered to the target. The  
3 herein described pixel package can be rotated as for  
4 example 360 degrees around it's axis and 360 degrees  
5 around an axis perpendicular to its' axis, and as a  
6 consequence has complete freedom of movement in both  
7 elevation and azimuth.

8           HORIZONTAL AXIS OPTICS: The target audience  
9 for signage and billboards typically moves horizontally  
10 as in vehicles. Horizontal axis optics provide for  
11 optimum control as the horizontal angular aperture is  
12 typically much greater than the vertical angular  
13 aperture.

14           ANGULAR APERTURE CONTROL: Minimizing the  
15 radiation beyond the angular extent needed for the task  
16 is an important element in minimizing cost. Maximizing  
17 the aperture to emitter size ratio allows a  
18 minimization of the angular extent of the output  
19 radiation. The herein described pixel design allows  
20 for a minimization of the output radiation by  
21 minimizing the emitter array size via close emitter  
22 spacing and a narrow gauge substrate and by maximizing  
23 the aperture size for a given pixel spacing.

24           BIFACIAL DISPLAY: Bifacial displays are  
25 possible with a single array of bifacial pixels or via  
26 a forward and rearward spaced pixel arrays, which may

1 provide or allow differing energizing content to the  
2 displays. The pixel package allows mounting in front  
3 of or in back of the display 'plane'. This allows  
4 one face to use pixel packages mounted on the front of  
5 the vertical wires and facing forward, and the opposite  
6 face to use pixel packages mounted on the opposite side  
7 of the wires and facing rearward. The packages may be  
8 displaced vertically to allow clearance.

9           TRANSPARENT DISPLAY: Displays can be made  
10 with a wide range of transparency to suit a variety of  
11 end uses.

12           OPTICAL EFFICIENCY: The pixel design allows  
13 for use of a linear emitter array coupled with a  
14 visible mirror film parabolic trough, to control  
15 radiation in the vertical axis. Horizontal axis  
16 radiation may be controlled by end reflectors of  
17 similar material and these may be curved to aid in the  
18 control of the angular extent of the radiation in the  
19 horizontal axis. This design minimizes the average  
20 number of reflections and provides for high efficiency  
21 for each reflection. The pixel optical system may be  
22 contained within a cylindrical glass envelope for  
23 environmental protection. Additional benefits of such  
24 an envelope include:

25           1) functioning as a circular compressive  
26 element to constrain the elastically deformed 3M VMF

1 and thereby cause it to form a parabolic curve; (The  
2 film is typically specularly reflecting film such as 3M  
3 visible mirror film. The reflecting film may be paired  
4 with/attached to additional film/s to provide the  
5 desired mechanical and other properties. The film/s  
6 may also be adhered to the container walls and/or  
7 constrained by lands/ridges/bumps along the container  
8 walls.)

9           2)     functioning as a container for a wide  
10 range of liquids, gels, solids, and/or smaller  
11 containers;

12           3)     functioning as a refractive optical  
13 element.

14           CONTRAST RATIO: Increasing the contrast  
15 ratio allows an improvement in visibility and/or a  
16 reduction in radiative power for a given visibility.  
17 The herein described configuration allows high contrast  
18 ratio viewing by:

19           1)     Minimizing the angular extent of the  
20 output radiation and increasing the aperture area of  
21 the output radiation reduces the probability of  
22 sunlight or other extraneous radiation being reflected  
23 from the 'display' to the target/viewer,

24           2)     Optical porosity (low solidity), which  
25 allows a portion of the radiation that would impinge on  
26 and possibly be reflected into the target on a high

1   solidity display pass through and be absorbed on a  
2   subsidiary surface/s,

3               3)    Insuring all surfaces within the targets  
4   field of view have very low reflectivity by means such  
5   as coating and texturing.

6               DETECTOR/DETECTOR ARRAY:   The described pixel  
7   may also operate as detectors, alone or in conjunction  
8   with emitters.

9               The lifetime and efficiency of semiconductor  
10   devices (LEDs) degrades strongly with increasing  
11   temperature. Provision is made for reducing the  
12   thermal resistance between the emitters and the local  
13   environment, and thereby increasing lifetime,  
14   reliability, durability, and efficiency and reduce  
15   operating cost, pursuant to provision of the following:

16              1)    A low solidity array which allows a  
17   portion of the solar load to be diverted to subsidiary  
18   surfaces and thereby make a smaller contribution to  
19   array heating. In addition, the open design allows  
20   airflow in and around the array and in very close  
21   thermal communication with the emitters.

22              2)    Wind enhanced cooling. A porous array  
23   allows the passage of and the ability to transfer heat  
24   to the local air stream. Wind speed increases strongly  
25   with increasing height and high mounted signage and  
26   displays may benefit greatly from this cooling.

1                   3)    Thermally induced convection cooling  
2    caused by the wire array, the pixel packages, and by  
3    proper design of subsidiary surfaces behind the array  
4    (horizontal axis overlapping slats/louvers).

5                   4)    Solar assisted cooling may be promoted  
6    by proper design of subsidiary louvered absorber array  
7    behind the screen. Louver surfaces with a high  
8    absorptivity for sunlight and a low infrared emissivity  
9    may be used to further increase airflow.

10                  5)    The pixel package enables use of a  
11    rectangular copper substrate for LED mounting. This  
12    substrate acts as a thermal, electrical, and structural  
13    conduit and its cross section may be easily sized to  
14    provide sufficiently low thermal resistance. The pixel  
15    package is thermally coupled to the row and column  
16    wires to aid in the transport of heat to the local  
17    environment. In addition, the pixel package may be  
18    liquid filled to allow reduced LED operating  
19    temperature.

20                  6)    Active cooling may be used if necessary,  
21    but its need and its cost may be greatly reduced by the  
22    aforementioned features.

23

24                   Provision is made for use of active and/or  
25    passively addressed pixels. Local (pixel based)  
26    electronics may be included in the pixel package and

1 placed on the emitter substrate, behind the reflector,  
2 in the aluminum bushing and/or in the hemispherical  
3 cap. Local electronics may vary with application and  
4 include capacitors, resistors, inductors, diodes,  
5 transistors, standard integrated circuits such as 555  
6 timers or application specific integrated circuits.  
7 Multiplexing may be used to reduce the cost of the  
8 electrical system, and the ability to multiplex is  
9 greatly increased by minimizing the pixel output  
10 radiation required by means discussed in the above  
11 optics section.

12           Provision is made for use of in-field  
13 replaceable pixels that may be made to be replaceable  
14 from either side of the screen.

15           Use of vertically oriented column/common  
16 wires and 45 degree oriented row/addressing wires to  
17 allows large scale seamless signage and displays with  
18 all pixels/electronics addressable/accessible from the  
19 top or the bottom of the screen.

20           Control electronics may be integrated into  
21 pixel packages; and/or control electronics may be  
22 concentrated in modules or zones at edge or edges of  
23 the arrays.

24           Provision is made for use of robust  
25 signage/displays created by arranging a parallel array  
26 of large diameter vertically oriented common/column

1 wires in tension between horizontal upper and lower  
2 rigid members. The upper end of each vertical wire may  
3 be formed into a loop and affixed to and electrically  
4 isolated from the upper rigid horizontal member. The  
5 lower end of each vertical wire may be formed into a  
6 loop and elastically attached to and electrically  
7 isolated from the lower rigid member by a stainless  
8 steel extension spring. Both upper and lower mounts  
9 may serve to prevent rotation of the vertical wires  
10 around their own axes. A parallel array of 45 degree  
11 row wires may be connected in tension between the upper  
12 and lower rigid horizontal members by means analogous  
13 to those described for the vertical wire array. The 45  
14 degree row wires may be constructed of a large diameter  
15 electrically insulated central wire helically wound  
16 with a 6 strand small diameter multifilar insulated  
17 wire array. The multifilar wire array includes paired  
18 red, green, and blue wires. The 45 degree wire array  
19 may be placed behind the vertical wire array and the  
20 pixel packages may be mounted in front of the vertical  
21 wires. The pixel packages may be mechanically  
22 connected to the vertical wires by plastic deformation  
23 of the pixel package aluminum bushing and/or the wire  
24 and/or by adhesives. The pixel common wire may be  
25 electrically connected to the large diameter vertical  
26 common wire through the aluminum bushing via



1 wirebonding or pressure welding or directly to the  
2 larger diameter wire by soldering or pressure type  
3 connection. Red, green, and blue wires emanating from  
4 the pixel may be connected to the 45 degree row wires  
5 by soldering or by pressure type contacts.

6           The row and column wires may be constructed  
7 of aluminum to reduce cost and weight for a given  
8 strength, electrical and thermal conduction. In  
9 addition, electrically insulative coatings adhere  
10 better and have longer life on aluminum than copper.

11           Signage and displays of simple or complex  
12 face or form (circular or hyperbolic cylinders, cones  
13 and conoids, hyperbolic paraboloids) may be assembled  
14 on site or shop fabricated by simple techniques that  
15 lend themselves to manual or automated fabrication.

16           Other important advantages are listed as  
17 follows:

18           1.   Organic Light Emitting Diodes: (OLEDS)  
19 may be used as light emitters alone or in conjunction  
20 with inorganic LEDs. OLEDs may be easier to apply to  
21 screen type substrates and may allow reduced product  
22 cost.

23           2.   Multiplexing: The ability to tailor the  
24 angular extent of the radiation output and the  
25 increased contrast provided by the OnScreen design

1 allows a greater degree of multiplexing and a  
2 concurrent reduction in system cost.

3           3.   45° Scanning: 45° scanning reduces line  
4 artifacts compared to vertical or horizontal scanning  
5 and thereby allows higher apparent resolution for a  
6 given number of pixels and/or a reduced number of  
7 pixels for a given apparent resolution.

8           4.   In Field Pixel Replaceability: The  
9 ability to replace individual pixels in the field  
10 allows reduced maintenance cost.

11           5.   Freedom of Form: Array construction  
12 allows a wide variety of signage/display forms. One  
13 example is a vertical axis cylindrical display viewed  
14 from the inside and/or the outside and with varying  
15 degree of array transparency determined by design.

16           6.   Shop Or Site Fabrication: The light  
17 weight and flexible nature of the OnScreen array  
18 coupled with the mechanism of flexible local linkage  
19 allows for shop fabrication of large area arrays.

20           7.   Pixel Level Voltage Reduction: Pixel  
21 ''on-board'' reduction allows higher array supply  
22 voltages and thereby lower current levels and reduced  
23 self-heating of array wiring and/or reduced wire cross-  
24 sectional area.

25

26